

Need a special component and footprint for this.

Has to have 6 rows of pads, with 22 pads on the right and left side for the 1000 mil ESP32-S3-WROOM board

The schematic symbol for this needs 89 pins

C6 UART 3x, SPI 3x, I2C 1x, I2S 1x  
C3 UART 2x, SPI 3x, I2C 1x, I2S 1x  
H2 UART 2x, SPI 3x, I2C 1x, I2S 1x  
S3 UART 3x, SPI 4x, I2C 2x, I2S 2x, SDIO host  
S2 UART 2x, SPI 4x, I2C 2x, I2S 1x

**S2F** Has a 700mil spacing on the inner pins  
Option is to overlay the pads such that the 3V3 of the S2F is on top of the 3V3 of the 4 super mini boards  
Only issue is with the C6 super mini that GPIO8 is overlapped by the EN pin and should thus not be used.  
The USB connectors can be on the same distance from the carrier board edge.

**C6 SM** These four super mini boards all have a 600mil spacing on the pins, and only overlap with the S2F with one row of pins.

**S3\_SM** The three supply pins are on the same location so no problem in overlap

H2 SM The GPIO matrix allows for full re allocation of the peripherals in software

G3 SM

ESP32 UART 3x, SPI 4x, I2C 2x, I2S 1x, SDIO host 1

